

No.	LCY-12T09062A
Date	June 9 th 2009

Technical Literature For TFT-LCD Module

Model No. LS027B4DH01

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Mobile Liquid Crystal Display Group SHARP CORPORATION



SPEC No. LCY-12T09602A

MODEL No.

LS027B4DH01

PAGE

1

<< Precautions>>

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Handling and System Design

- ① Handle with care as glass is used in this LCD panel. Dropping or contact against hard object may cause cracks or chips.
- ② Do not scratch the surface of UV protection film as it is easily damaged.
- 3 Water droplets on the UV protection film must be wiped off immediately as they may cause discoloration or other defects if left for 10 minutes or longer.
- To clean LCD panel surface, wipe clean with absorbent cotton or soft cloth. If further cleaning is needed, use IPA (isopropyl alcohol) and wipe clean lightly on surface only. Do not use organic solvents as it may damage the LCD panel terminal area which uses organic material. Also, do not directly touch with finger.
- 5 To avoid circuit failure, do not touch panel terminal area.
- ⑥ Do not expose gate driver, etc. on the panel (circuit area outside panel display area) to light as it may not operate properly. Design that shields gate driver, etc. from light is required when mounting the LCD module.
- ② Support for the LCD panel should be carefully designed to avoid stress that exceeds specification on glass



LCY-12T09602A

MODEL No.

LS027B4DH01

PAGE

2

surface.

- **8** LCD panel is susceptible to mechanical stress and such stress may affect the display. Place the panel on flat surface to avoid stress caused by twist, bend, etc..
- When transporting LCD panels, secure them in LCD panel tray to avoid mechanical stress. The tray should be conductive to protect LCD panels from static charge.
 Material used in set or epoxy resin (amine type hardening agent) from packaging, and silicon adhesive (dealcoholized or oxime) all release gas which may affect quality of UV protection film. Do confirm
- 10 Do not use chloroprene rubber as it generates chlorine gas and affects reliability in LCD panel connective area.
- ① This LCD module is sensitive to electrostatic discharge of 200V or more. Handle with care using cautions for the followings:
 - Operators
 - Operators must wear anti-static wears to prevent electrostatic charge up to and discharge from human body.
 - Equipment and facility

compatibility with user materials.

- Process equipment such as conveyer, soldering iron, working bench and containers may possibly generate electrostatic charge and discharge. Equipment must be grounded through 100Mohms resistance.
- Floor
 - Floor plays an important role in leaking static electricity generated in human body or equipment. If the floor is made of insulated material (such as polymer or rubber material), such static electricity may charge. Proper measure should be taken to avoid static electricity charge (electrostatic earth: 100Mohms).
- Humidity
 - Humidity in work area relates to surface resistance of the persons or objects that generate electrostatics, and it can be manipulated to prevent electrostatic charge. Humidity of 40% or lower increases electrostatic earth resistance and promotes electrostatic charging. Therefore, the humidity in the work area should be kept above 40%. Specifically for film peeling process or processes that require human hands, humidity should be kept above 50% and use electricity removal blower.
- Transportation/Storage
 - Containers and styroform used in transporation and storage may charge electrostatic (from friction and peeling) or electrostatic charge from human body, etc. may cause containers and styroform to have induced charge. Proper electrostatic measure should be taken for containers and storage material.
- (2) Protective film is attached to the surface of UV protection film on LCD panel to prevent scratches or other damages. Remove this protective film before use.



SPEC No. MODEL No.

LS027B4DH01

PAGE

3

Operating the module

LCY-12T09602A

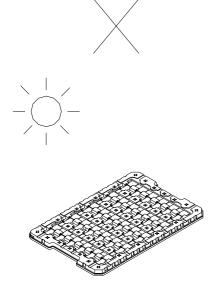
- ① Do not operate the LCD panel above specified voltage as it may cause the LCD panel to faile. Always operate within specified rating.
- ② Do not use the LCD panel outside AC timing rating, etc., specified in this specification as it may cause display failure. Always use the panel thin specified rating.

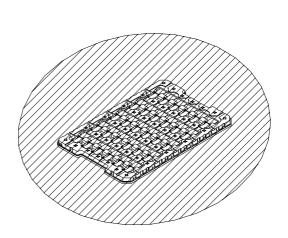
Storing the module

- ① After opening the package, do not leave the LCD panel in direct sun or under strong ultraviolet ray. Store in dark place.
- ② In temperature lower than specified rating, liquid crystal material will coagulate. In temperature higher than specified rating, it isotropically liquifies. In either condition, the liquid crystal may not recover its original condition. Store the LCD panel in at or around room temperature as much as possible.

 Also, storing the LCD panel in high humidity will damage the polarizer. Store in normal room temperature as much as possible.
- 3 Storing
 - a. No direct sun light

b. Store in trays and in dark room







LCY-12T09602A

MODEL No.

PAGE

LS027B4DH01

4

Others

- ① Operation outside specified environmental conditions cannot be guaranteed.
- ② As power supply (VDD-GND, VDDA-GND) impedance is lowered during use, bus controller should be inserted near LCD module as much as possible.
- ③ UV protection film is applied over LCD panel surface. Liquid crystal inside LCD panel deteriorates with ultraviolet ray. The panel should not be left in direct sun or under strong ultraviolet ray for prolonged period of time even with the UV protection film.L
- 4 Disassembling the LCD module will cause permanent damage to the module. Do not disassemble the module.
- (5) If LCD panel is broken, do not ingest the liquid crystal from the broken panel. If hand, leg, or clothes come in contact with liquid crystal, wash off immediately with soap.
- © ODS (specific chlorofuorocarbon, specific halon, 1-1-1 trichloroethane, carbon tetrachloride) are not used or contained in material or all production processes of this product.
- ① Observe all other precautionary requirements in handling general electronic components.

Discarding liquid crystal modules

LCD Panel : Dispose of as glass waste. This LCD module contains no harmful substances.

The liquid crystal panel contains no dangerous or harmful substances.

This liquid crystal panel contains only an extremely small amount of liquid crystal (approximately 100mg) and therefore it will not leak even if the panel should break.

Its median lethal dose (LD50) is greater than 2,000 mg/kg and a mutagenetic (Aims test: negative) material is used.

FPC : ①FPC bend R should be 0.45mm or greater and R should be even.

In LCD panel an connective area, do not bend FPC into UV protection film side.

2Do not hang LCD module by FPC or apply force to FPC.



LCY-12T09602A

MODEL No.

LS027B4DH01

PAGE

5

Index

1. Scope of Application • • • • • P6
2. Overview
3. Mechanical Specification P6
4. Input Terminal Names and Functions P7
5. Absolute Maximum Rating·····P8
6. Electrical Characteristics P8
7. Optical Characteristics P19
8. Outline Dimension ·····P21
9. External Circuit Example P22
10.External Power Supply Circuit •••••••P23
11.Packaging •••••••••••••••••••••••••••••••••••
12.Reliability Test Conditions P26



SPEC No. MODEL No.

LCY-12T09602A LS027B4DH01

PAGE

6

1. Scope of Application

Reflective active-matrix type memory liquid crystal display module with WQVGA (400x240) panel which uses CG silicon thin film transistor.

2. Overview

- 2.7" WQVGA monochrome reflective panel
- 400x240 dot stripe arrangement
- Display control with serial data signal communication
- · Arbitrary line data update
- · Internal 1bit memory within the panel for data memory
- · Thin, light and compact module with monolithic technology
- Super low power consumption TFT panel
- With FPC (Applicable connector: Refer to recommended connector on page 21.)

3. Mechanical Specification

Tabke 3-1 Module Mechanical Specification

Item	Specification	Unit
Screen Size (Diagonal)	6.86cm (2.7")	cm
Viewing Area	58.8 (H) × 35.28 (V)	mm
Dot Structure	400 (H) × 240 (V)	dot
Dot pitch	0.147 (H) × 0.147 (V)	mm
Pixel Arrangement	Stripe arrangement	_
Module outline dimension (Extruded part not included)	62.8 (W) × 42.82 (H) × 1.53 (D)	mm
Weight	TBD (TYP)	g
Surface Hardness	3H or more (Initial)	Pencil
		hardness

(Remark) Refer to Figure 8-1 for detailed dimension and tolerance.



LCY-12T09602A

MODEL No.

PAGE

LS027B4DH01

7

4. Input Terminal names and function

4-1) Input Terminal

Table 4-1

Terminal	Code	1/0	Function	Remark
1	SCLK	INPUT	Serial clock signal	
2	SI	INPUT	Serial input signal	
3	SCS	INPUT	Chip select signal	
4	EXTCOMIN	INPUT	External COM inversion signal input (H: Active)	
5	DISP	INPUT	Display ON/OFF signal	Remark 4-2
6	VDDA	POWER	Analalog power supply	
7	VDD	POWER	Digital power supply	
8	EXTMODE	INPUT	COM inversion mode switch terminal	Remark 4-1
9	VSS	POWER	Logic GND	
10	VSSA	POWER	Analog GND	

Remark 4-1] "H"=EXTCOMIN singal enabled, "L"=Serial input flag enabled.

When "H", connect EXTMODE to VDD and when "L" to VSS.

Remark 4-2 ON/OFF for LCD display only. Memory data is maintained.

When "H", displays with memory data, and when "L", displays all white with memory data maintained.

4-2) Recommended Circuit

COM signal serial input

EXTMODE="L"

COM Signal Serial Input EXTMODE=L

	1	SCLK
	2	SI
	3	SCS
	4	EXTCOMIN
	5	DISP
	6	VDDA
	7	VDD
	8	EXTMODE
-	9	VSS
	10	VSSA

External COM signal input EXTMODE="H"

External COM Signal Input EXTMODE=H

	1	SCLK
	2	SI
	3	SCS
	4	EXTCOMIN
	5	DISP
	6	VDDA
\rightarrow	7	VDD
	8	EXTMODE
	9	VSS
	10	VSSA



LCY-12T09602A

MODEL No.

LS027B4DH01

PAGE

8

5. Absolute Maximum Rating

Table 5-1 **(**SND=0V**)**

	Item	Code	MIN.	MAX.	Unit	Remark
Power	Power Analog Power Supply		-0.3	+5.8	V	
supply	Logic Power Supply	VDD	-0.3	+5.8	V	Remark 5-1
Voltage						
Input signal terminal voltage (high)				VDD	V	Remark 5-2
Input signal	terminal voltage (low)		-0.3		V	
Storage temperature		Tstg	-30	+80	°C	Remark 5-3,4
Operating temperature		Topr1	-20	+70	°C	Remark 5-5
(Panel surfa	ace temperature)					

Remark 5-1 Also applicable to EXTMODE.

Remark 5-2 Applicable to SCLK, SI, SCS, DISP, EXTCOMIN.

Remark 5-3 Do not exceed this rating in any area of the module.

Remark 5-4] Maximum wet-bulb temperature should be 57°C or lower. Do not allow condensation.

Condensation may cause electrical leak and the module may not meet s specification.

Remark 5-5] Operating temperature is temperature that guarantess operation only. For contrast, response speed, and other display guty, module is evaluated at Ta=+25°C.

6. Electrical Characteristics

6-1)TFT LCD Panel Driving Part

Table 7-1 Recommended Operating Condition

VSS(GND) = 0V, Ta = +25°C

Item		Code	MIN.	TYP.	MAX.	Unit	Remark
Power supply	Analog power Supply	VDDA	+4.8	+5.0	+5.5	٧	
voltage	Logi power supply	VDD	+4.8	+5.0	+5.5	٧	Remark 6-1
Input singal	Hi	VIH	+2.70	+3.00	₩VDD	V	Remark 6-2
voltage	Lo	VIL	VSS	VSS	VSS+0.15	٧	
Inputleak	Hi	IOH	-	-	TBD	uA	Remark 6-2
current							VI=3V
	Lo	IOL	-	-	TBD	uA	Remark 6-2
							VI=0V

*Can operate below VDD voltage, however, operation around 3V is recommended.

Remark 6-1 Also applicable to EXTMODE="H".

Remark 6-2 Applies to SCLK, SI, SCS, DISP, EXTCOMIN.

SHARP

SPEC No.

MODEL No.

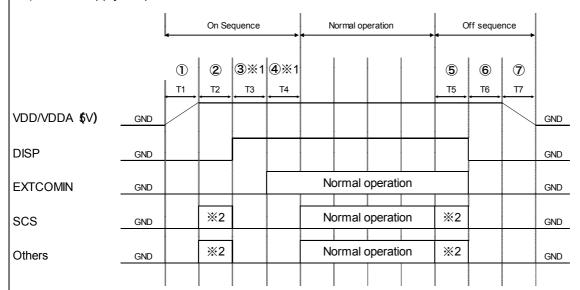
PAGE

LCY-12T09602A

LS027B4DH01

9

6-2) Power Supply Sequence



*Refer to timing chart and AC timing characteristics for detail

**1 ③ and ④ may be opposite (however, TCOM polarity inversion will not occur even with EXTCOMIN between DISP="L". Also, when DISP and EXTCOMIN are simultaneously started up, allow 30us or more before SCS starts up (It may be less than 60us).

※2 Setting value for pixel memory initialization

SCS=Driving accordingly to clear pixel internal memory method (use all clear flag or write all screen white)

S1=M2 (all clear flag) = "H" or write white

SCLK: Normal Driving

[ON Sequence]

- (1) 5V rise time (depends on IC)
- (2) Pixel memory initialization T2: 1V or more Initialize with M2 (all clear flag) or write all screen white
- (3) Release time for initialization of TCOM latch T3: 30us or more

Time required to release COM related latch circuit initialization which is initializing using DISP signals

(4) TCOM polarity initialization time T4: 30us or more

Time required initializing TCOM polarity accordingly to EXTCOMIN input

[Normal Operation]

Duration of normal driving

[Off Sequence]

(5) Pixel memory initialization time T5: 1V or more

(6) VA, VB, VCOM initialization time T6: 1V or more

(7) 5V falling time (Depends on IC)

Remark Cautions when powering on

Remark 1) VDD and VDDA should rise simultaneously or VDD should rise first.

Remark 2) VDD and VDDA should simultaneously or VDD should fall first



MODEL No.

LS027B4DH01

PAGE

34DH01 10

6-3) Input Signal Basic Characteristics

Table 6-3-1

VDDA=+5.0V, VDD=+5.0V, GND=0V, Ta=25°C

Item	Code	MIN	TYP	MAX	Unit	Remark
Frame Frequency	fSCS	1	-	20	Hz	
Clock Frequency	fSCLK		1	2	MHz	
Vertical rush duration	tV	49.993	-	1000	ms	
COM Frequency	fCOM	0.5	-	10	Hz	

LCY-12T09602A

Table 6-3-2

VDDA=+5.0V, VDD=+5.0V, GND=0V, Ta=25°C

Item	Code	MIN	TYP	MAX	Unit	Remark
SCS rising time	trSCS			50	ns	
SCS falling time	tfSCS			50	ns	
SCS High width	twSCSH	220			us	Data update mode
		12			us	Display mode
SCS Low width	twSCSL	1			us	
SCS setup time	tsSCS	3			us	
SCS hodl time	thSCS	1			us	
SI rising time	trSI			50	ns	
SI falling time	tfSI			50	ns	
SI set upt time	tsSI	120			ns	
SI hold time	thSI	190			ns	
SCLK rising time	trSCLK			50	ns	
SCLK falling time	tfSCLK			50	ns	
SCLK High width	twSCLKH	200	450		ns	
SCLK Low width	twSCLKL	200	450		ns	
EXTCOMIN signal frequency	fEXTCOMIN		1	20	Hz	Remark 6-3
EXTCOMIN signal rising time	trEXTCOMIN			50	ns	
EXTCOMIN signal falling time	tfEXTCOMIN			50	ns	
EXTCOMIN signal High width	twEXTCOMIN	1			us	
DISPrising time	trDISP			50	ns	
DISP falling time	tfDISP			50	ns	

Remark 6-3] EXTCOMIN frequency should be made lower than frame frequency.



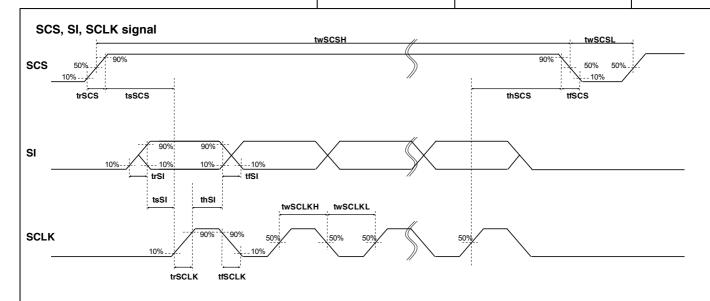
LCY-12T09602A

MODEL No.

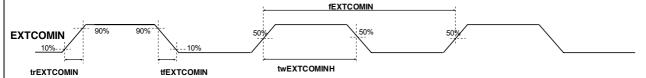
LS027B4DH01

PAGE

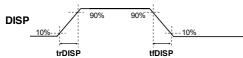
11



EXTCOMIN signal



DISP signal



****SCS,SI,SCLK, DISP, EXTCOMIN:** 3V input voltage



LCY-12T09602A

MODEL No.

LS027B4DH01

Ta=25℃

PAGE

12

6-4) Power Consumption (Average)

Table 6-4

Item	Code	MIN	TYP	MAX	Unite	Remark
Measurement			T.B.D		uW	Remark 6-4
Condition 1						
Measurement			T.B.D		uW	Remark 6-4
Condition 2						

*Measurement Condition 1

Display mode (no display data update), Display pattern: Vertical stripe display

* Measurement Condition 2

Data update mode (with display data update: 1Hz)

Common inversion with VDD=5V, VDDA=5V, fSCLK=1MHz, fSCS=1Hz, Display pattern: Vertical stripe display

Remark 6-4 This is value in steady condition, not the falue of peak power at the time of COM operation. Some marging for power supply is recommended. We recommend capacitor for VDD and VDDA. (If VDD and VDDA are on separate systems, we recommend capacitor for each.)



LCY-12T09602A

MODEL No.

LS027B4DH01

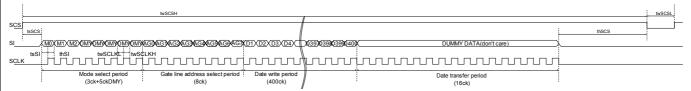
PAGE

13

6-5) Input Signal Timing Chart

6-5-1 Data update mode (1 line)

Updates data of only one specified line. (M0="H", M2="L")



M0: Mode flag. Set for "H". Data update mode (Memory internal data update)

When "L", display mode (maintain memory internal data).

M1: Frame inversion flag.

When "H", outputs VCOM="H", and when "L", outputs VCOM="L".

When EXTMODE="H", it can be "H" or "L".

M2: All clear flag.

Refer to 6-5-4) All Clear Mode to execute clear.

DUMMY DATA: Dummy data. It can be "H" or "L" ("L" is recommended.)

Data write period

Data is being stored in 1st latch block of binary driver on panel.

Data transfer period

Data written in 1st latch is being transferred (written) to pixel internal memory circuit.

※For gate line address setting, refer to 6-6) Input Signal and Display.

*M1: Frame inversion fl is enaled when EXTMODE="L".

*When SCS becomes L", M0 and M2 are cleared.



LCY-12T09602A

MODEL No.

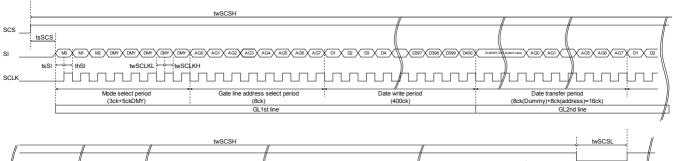
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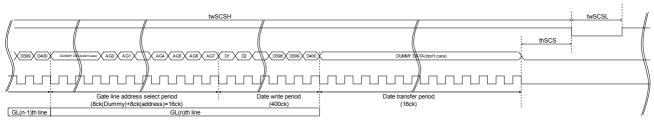
PAGE

14

6-5-2 Data Update Mode (Multiple Lines)

Updates arbitrary multiple lines data. (M0="H", M2="L")





M0: Mode flag. Set for "H". Data update mode (Memory internal data update)

When "L", display mode (maintain memory internal data).

M1: Frame inversion flag.

When "H", outputs VCOM="H", and when "L", outputs VCOM="L".

When EXTMODE="H", it can be "H" or "L".

M2: All clear flag.

Refer to 6-5-4) All Clear Mode to execute clear.

DUMMY DATA: Dummy data. It can be "H" or "L" ("L" is recommended.)

Data write period

Data is being stored in 1st latch block of binary driver on panel.

Data transfer period

For example, during GL2nd line data transfer period, GL 2nd line address is latched and GL1st line data is transferred from 1st latch to pixel internal memory circuit at the same time.

- ※ For gate line address setting, refer to 6-6) Input Signal and Display.
- Input data continuously.
- M1: Frame inversion flag is enabled when EXTMODE="L".
- When SCS becomes ft", M0 and M2 are cleared.



LCY-12T09602A

MODEL No.

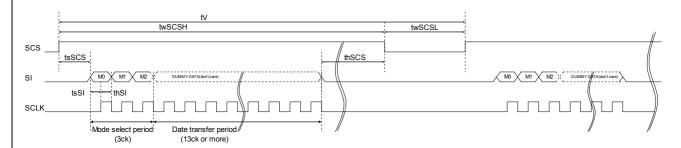
LS027B4DH01

PAGE

15

6-5-3 Display Mode

Maintains memory internal data (maintains current display). (M0="L", M2="L")



M0: Mode flag. Set for "H". Data update mode (Memory internal data update)

When "L", display mode (maintain memory internal data).

M1: Frame inversion flag.

When "H", outputs VCOM="H", and when "L", outputs VCOM="L".

When EXTMODE="H", it can be "H" or "L".

M2: All clear flag.

Refer to 6-5-4) All Clear Mode to execute clear.

DUMMY DATA: Dummy data. It can be "H" or "L" ("L" is recommended.)

M1: Frame inversion flag is enabled when EXTMODE="L"

*When SCS becomes "L", M0 and M2 are cleared.



LCY-12T09602A

MODEL No.

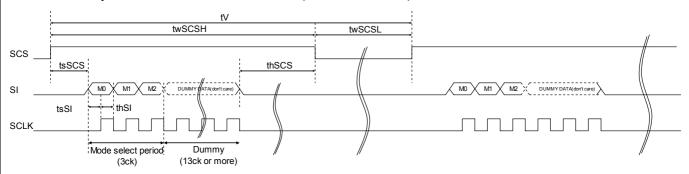
LS027B4DH01

PAGE

16

6-5-4 All Clear Mode

Clears memory internal data and writes white. (M0="L", M2="H")



M0: Mode flag.

Set it "L".

M1: Frame inversion flag.

When "H", outputs VCOM="H", and when "L", outputs VCOM="L".

When EXTMODE="H", it can be "H" or "L".

M2: All clear flag.

Set it "H"

DUMMY DATA: Dummy data. It can be "H" or "L" ("L" is recommended.)

M1: Frame inversion flag is enabled when EXTMODE="L".

*When SCS becomes £", M0 and M2 are cleared.



MODEL No.

LS027B4DH01

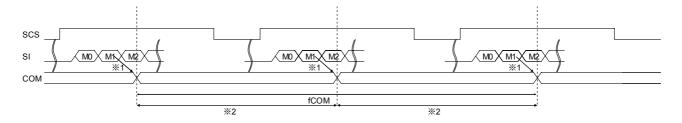
PAGE

17

6-5-5 COM Inversion

There are two types of inputs, COM signal serial input (EXTMODE="L") and external COM signal input (EXTMODE="H"). <u>EXTMODE="L"</u>

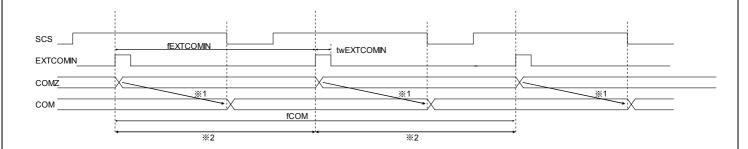
LCY-12T09602A



M1 LC polarity inversion flag: If M1is "H" then VCOM="H" is output. If M1 is "L" then VCOM="L" is output.

- %1 LC inversion has been changed by M1 flag statement.
- *2 The periods of plus polarity and minus polarity should be same length as much as possible.

EXTMODE="H"



※2 The period of EXTCOMIN should be constant.



LCY-12T09602A

MODEL No.

PAGE

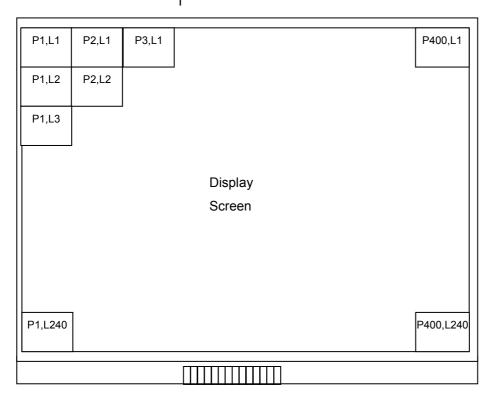
LS027B4DH01

18

6-6) Input Signal and Screen Display, Gate Address (Line) Setup

Data screen display position (H,V)





	Gate Line Address Setup								
Line	AG0	AG1	AG2	AG3	AG4	AG5	AG6	AG7	
L1	Н	L	L	L	L	L	L	L	
L2	L	Н	L	L	L	L	L	L	
L3	н	н	L	L	L	L	L	L	
•	•	•	•	•	•	•	•	•	
•	•	•	•	•	•	•	•	•	
•	•	•	•	•	•	•	•	•	
L238	L	Н	н	Н	L	Н	Н	Н	
L239	Н	Н	Н	Н	L	Н	Н	Н	
L240	L	L	L	L	Н	Н	Н	Н	



LCY-12T09602A

MODEL No.

LS027B4DH01

PAGE

19

7. Optical Characteristics

Table 7-1 Ta=25°C

Item		Code	MIN.	TYP.	MAX.	Unit	Remark
Viewing Angle	Н	θ 21, θ 22		TBD		°(Degree)	Remark 7-1]
CR≧5	V	θ 11		TBD		°(Degree)	
		0 12		TBD		°(Degree)	
Contrast Ratio		CR.	TBD	14			Remark 7-2.
							3]
Reflection Ratio		R		20		%	Remark 7-3
Response	Rise	τr		50		ms	Remark
Speed	Fall	τ d		50		ms	7-3,4】
Panel Surface	White	Х		0.312			Remark 7-3
Chromaticity		у		0.329			

Remark 7-3 Optical Characteristics Measurement Equipment

Contrast ratio, reflective ratio and panel surface chromaticity are measured as shown in figure 7-2, and Response speed is measured as shown in Figure 7-3. Both measurement methods are done in dark Room or equivalent.

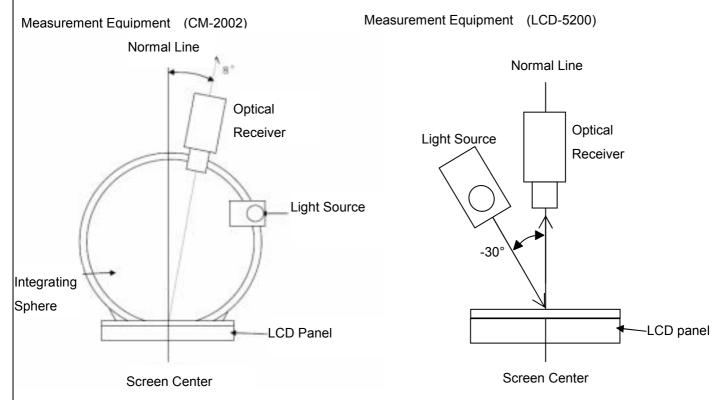


Figure 7-2 Measurement of contrast, reflective ratio and panel surface chromaticity



LCY-12T09602A

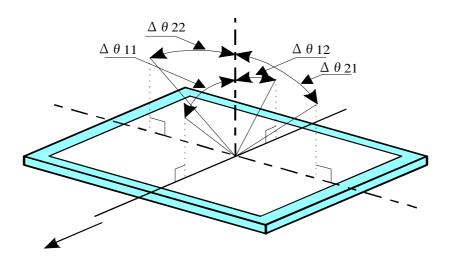
MODEL No.

LS027B4DH01

PAGE

20

Remark 7-1 Definition of Viewing Angle



Remark 7-2 Definition of Contrast Ratio Defined as shown in below formula

Remark 7-4 Definition of Response Speed (Reflection Ratio Change)

Input signal for white and black as shown below and define by the change in time it takes for optical receiver output.

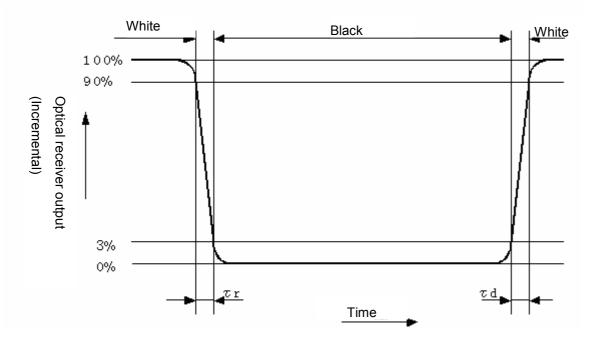


Figure 7-3 Measurement of response speed



LCY-12T09602A

MODEL No.

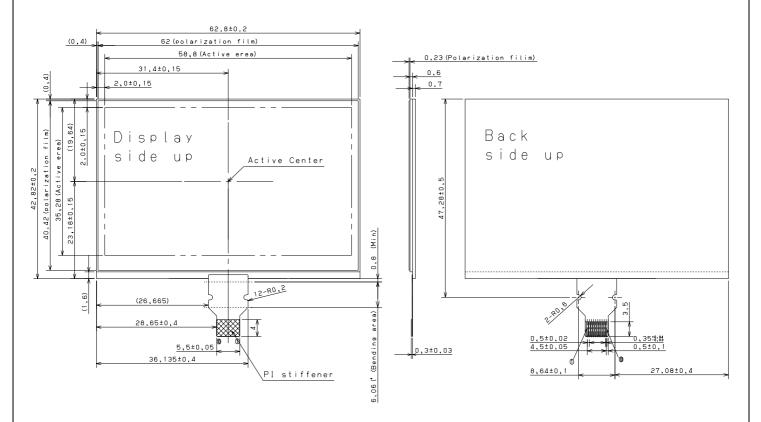
LS027B4DH01

PAGE

21

8. Outline Dimension

Figure 8-1 2.7" WQVGA Monochrome Outline Dimension



Recommended Connector > SMK (Bottom Contact) FP12 Series: CFP-4610-0150F

8-2) FPC Bend Specification

When bending FPC, bend where specified in Condition (1) and the bend R should be more than R specified in Condition (2). FPC is not to contact glass edge, and there should be no stress to connective area between panel and FPC.

Condition (1) FPC bend recommended area: 0.8mm – 6.0mm from glass edge.

Condition (2) Minimum bend R: Inner diameter R0.45



Figure 8-2

Remark 8-1 Do not bend backward (toward UV protection film side)

Remark 8-2] Bend frequency: 3 times or less (Repeat bend condition: 180° ~ 0°)

<Recommended Connector> SMK (Top Contact) FP12 series CFP-4510-0150F



LCY-12T09602A

MODEL No.

LS027B4DH01

PAGE

22

9. External Circuit Example

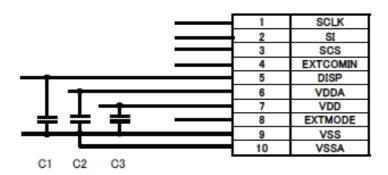


Figure 9-1 External Circuit (Recommended)

< Recommended Capacitor >

C1: Between DISP-VSS, B characteristics 0.1uF ceramic capacitor

C2: Between VDDA-VSS, B characteristics 0.1uF or more cerac capacitor

C3: Between VDD-VSS, B characteristics 1uF or more ceramic capacitor

*Above circuit and parts are only recommendation.

For actual use, please evaluate their conformity with your system and design.

(Capacitor pressure resistance can be larger than resistance indicated above.)



LCY-12T09602A

MODEL No.

LS027B4DH01

PAGE

23

10. External Power Supply Circuit

An external power supply circuit is necessary to drive the memory LCD with 3V battery.

Table 10-1 shows recommended power supply IC>

Table 10-1

Vendor	Model No.	Note	
SII	S-8821	Charge pump type	
National Semiconductor	LM2750	Charge pump type	

Remark 10-1] For detailed specification, refer to specification for each power supply IC.

Remark 10-2] To use, set constant value after sufficient evaluation of actual application.

Electrical Characteristics

Table 10-2

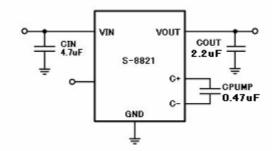
Madal Na	Vin	[V]	Vout			lout
Model No.	min	max	min	typ	max	[A]
S-8821	2.8	5.0	4.9	5.0	5.1	0.04
LM2750	2.7	5.6	4.8	5.0	5.2	0.04

Remark 10-3] For detailed specification, refer to specification for each power supply IC.

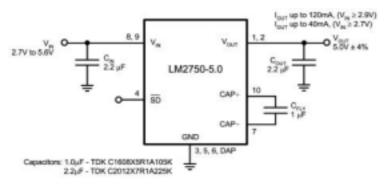
Remark 10-4 To use, set constant value after sufficient evaluation of actual application.

Reference Circuit

Reference circuit is shown below.



S-8821



LM2750



LCY-12T09602A

MODEL No.

LS027B4DH01

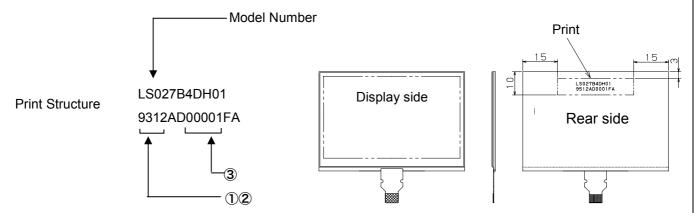
PAGE

24

11. Packaging

11-1) Lot number

Will be indicated on serial number label as indicated in Figure 11-1 outline dimension figure.



Serial number specification

- ①Last digit of the year
- 2 Month and date of manufacture
- 35 digit consecutive numbers

Figure 11-1 Serial number print location

SHARP

SPEC No.

LCY-12T09602A

MODEL No.

LS027B4DH01

PAGE

25

11-2) Package Storing

①Maximum number of carton in a stack: 8 cartons

Maximum quantity of units in carton: 800 units per carton

2Storage condition

•Temperature: 0~40°C

Humidity: 60%RH or lower (at 40°C)

There should be no condensation at low temperature and high humidity.

Atmosphere: No harmful gas, such as acid or alkali, which causes severe corrosion on electronic parts and wiring,

are to be detected.

Period: About 3 months

Opening the package: in order to prevent electrostatic damage to TFT modules, room humidity should be made

over 50%RH and take effective measure such as use of earth when opening the package.

11-3) Packaging

Packaging condition is shown in Figure 11-2.

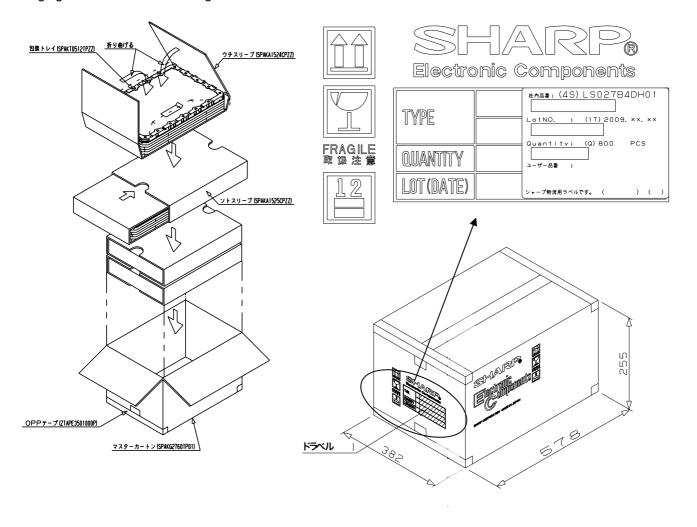


Figure 11-2 Packaging Condition



LCY-12T09602A

MODEL No.

LS027B4DH01

PAGE

26

12. Reliability Test Conditions

12-1) Reliability test items

Table 12-1 Reliability test items

	Test items	Test condition	Remark	
1	High temperature storage	Ta=80°C 240h (Non-operating)		
2	Low temperature storage	Ta=-30°C 240h (Non-operating)		
3	High temperature/humidity operation	Tp=40° C /95%RH 240h		
4	High temperature operation	Tp=70° C 240h		
5	Low temperature operation	Tp=-20° C 240h		
6	Heat shock	Ta=-30°C(1h)~+80°C(1h)/cycle=5cycle (Non-operating)		
7	Electrostatic discharge	±200V、200pF(0Ω) 1 time/each terminal		

Note Ta=Surrounding temperature, Tp=Panel temperature

(Evaluation method)

In standard condition, there shall be no practical problems that may affect the display function.

12-2) Panel surface stress specification

"Force of stress [N]" without display failure (display non-uniformity) is defined as follow:

Load testing (minimum): 120[N] or higher

Test conditions) Module: LCD panel

Load point: LCD panel center (glass cloth tape applied in load point area)

Press jig: ϕ 10mm cylinder Press speed: 1mm/minute Support: Secured on stage

Press time: Hold for 5 seconds after reaching test press load and then release

SHARP

SPEC No.

LCY-12T09602A

MODEL No.

LS027B4DH01

PAGE

27